

# DCP01 シリーズ、1W、1000V<sub>RMS</sub> 絶縁型、非安定型 DC/DC コンバータ・モジュール

## 1 特長

- 1kV 絶縁 (動作上) : 1 秒間テスト
- 絶縁バリアの両側に連続的な電圧を印加: 60VDC / 42.5VAC
- UL1950 認定部品
- EN55022 Class B の EMC に準拠
- 7 ピン PDIP および 7 ピン SOP パッケージ
- 入力電圧: 5V、15V、24V
- 出力電圧:  $\pm 5V$ 、 $\pm 6.5V$ 、 $\pm 12V$ 、 $\pm 15V$
- デバイス間の同期
- 過熱保護機能
- 短絡保護
- 高効率

## 2 アプリケーション

- 信号パス絶縁
- グランド・ループの除去
- データ・アキュイジション
- 産業用制御および計測機器
- 試験用機器

## 3 概要

DCP01B シリーズは、1W、絶縁型、非安定型 DC/DC コンバータ・モジュールのファミリです。必要な外付け部品が最小限で、オンチップのデバイス保護が搭載されているため、DCP01B シリーズのデバイスは出力ディセーブルやスイッチング周波数の同期などの追加機能も提供できます。

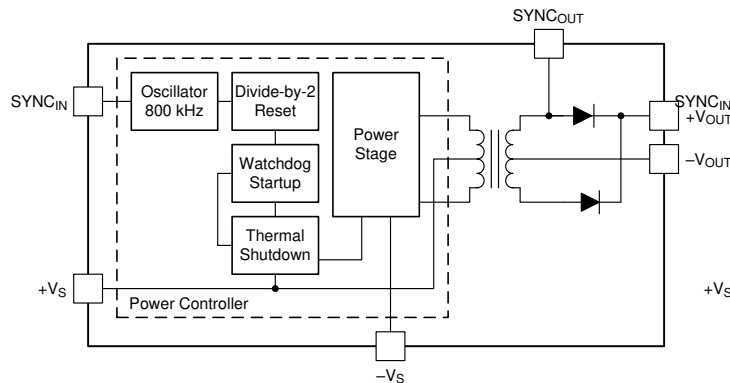
これらの機能に加え、小型サイズであることから、DCP01B シリーズのデバイスは広範なアプリケーションに適しており、信号パスの絶縁が必要なアプリケーションで簡単に使用できるソリューションです。

**警告:** この製品の動作絶縁は、信号の絶縁のみを意図したものです。強化絶縁を必要とする安全用の絶縁回路の一部として使用してはいけません。「機能説明」の定義を参照してください。

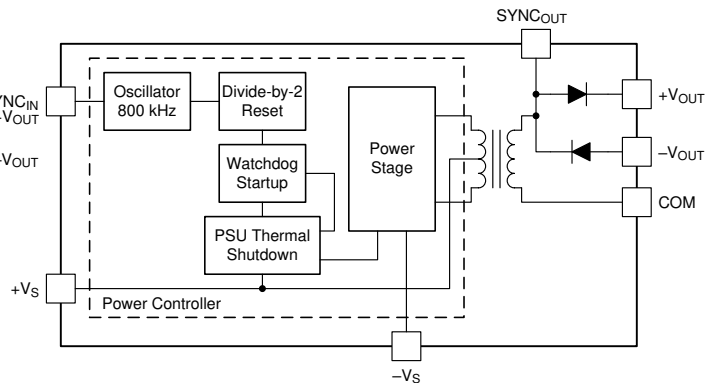
### 製品情報

型番	パッケージ <sup>(1)</sup> (1 ページ)	本体サイズ (公称)
DCP01xxxxB	PDIP (7)	19.18mm×10.60mm
	SOP (7)	

(1) 利用可能なすべてのパッケージについては、このデータシートの末尾にある注文情報を参照してください。



単一出力のブロック図



デュアル出力のブロック図



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## 4 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

<b>Changes from Revision H (May 2019) to Revision I (April 2020)</b> .....	<b>Page</b>
• 文書全体にわたって表、図、相互参照の採番方法を更新.....	1
• 以下へのリンクを追加 <a href="#">セクション 2</a> (1 ページ) .....	1
<b>Changes from Revision G (February 2017) to Revision H (May 2019)</b> .....	<b>Page</b>
• Added <a href="#">セクション 7.3.6</a> .....	14
• Added <a href="#">セクション 7.3.7</a> .....	14
• Added <a href="#">セクション 7.3.10</a> .....	15
<b>Changes from Revision F (October 2015) to Revision G (February 2017)</b> .....	<b>Page</b>
• Adjusted Operating temperature specification to "ambient temperature range, $T_A$ " in <a href="#">セクション 6.3</a> .....	5
<b>Changes from Revision E (December 2000) to Revision F (October 2015)</b> .....	<b>Page</b>
• 追加日 <a href="#">図 3-1</a> (1 ページ) .....	1
• Renamed pin "0V" to "COM" (output side common pin) in <a href="#">セクション Pin Functions</a> .....	4
• Renamed pin "V <sub>S</sub> " to "+V <sub>S</sub> " (input voltage pin) in <a href="#">セクション Pin Functions</a> .....	4
• Renamed pin "0V" to "-V <sub>S</sub> " (input side common pin) in <a href="#">セクション Pin Functions</a> .....	4
• Added <a href="#">セクション 6.3</a> .....	5
• Added <a href="#">セクション 6.4</a> .....	5
• Added information to the ISOLATION section of <a href="#">セクション 6.5</a> .....	6
• Added <a href="#">セクション 7.3.1</a> to <a href="#">セクション 7.3</a> .....	13
• Added a typical application design to <a href="#">セクション 8.1</a> .....	18
• Added <a href="#">セクション 9</a> .....	22

## Device Comparison Table

at  $T_A = 25^\circ\text{C}$ ,  $+V_S = \text{nominal}$ ,  $C_{IN} = 2.2\ \mu\text{F}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$ , (unless otherwise noted)

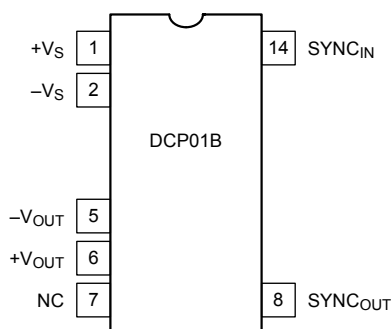
DEVICE NUMBER	INPUT VOLTAGE $V_S$ (V)			OUTPUT VOLTAGE $V_{NOM}$ AT $V_S$ (TYP) (V) 75% LOAD			DEVICE OUTPUT CURRENT (mA) <sup>(3)</sup>	LOAD REGULATION 10% TO 100% LOAD <sup>(1)</sup>		NO LOAD CURRENT $I_Q$ (mA) 0% LOAD	EFFICIENCY (%) 100% LOAD	BARRIER CAPACITANCE $C_{ISO}$ (pF) $V_{ISO} = 750V_{rms}$
	MIN	TYP	MAX	MIN	TYP	MAX	MAX	TYP	MAX	TYP	TYP	TYP
DCP010505BP DCP010505BP-U	4.5	5	5.5	4.75	5	5.25	200	19	31	20	80	3.6
DCP010505DBP DCP010505DBP-U				±4.25	±5	±5.75	200 <sup>(2)</sup>	18	32	22	81	3.8
DCP010507DBP DCP010507DBP-U				±5.75	±6.5	±7.25	153 <sup>(2)</sup>	21	35	38	81	3.0
DCP010512BP DCP010512BP-U				11.4	12	12.6	83	21	38	29	85	5.1
DCP010512DBP DCP010512DBP-U				±11.4	±12	±12.6	83 <sup>(2)</sup>	19	37	40	82	4.0
DCP010515BP DCP010515BP-U				14.25	15	15.75	66	26	42	34	82	3.8
DCP010515DBP DCP010515DBP-U				±14.25	±15	±15.75	66 <sup>(2)</sup>	19	41	42	85	4.7
DCP011512DBP DCP011512DBP-U	13.5	15	16.5	±11.4	±12	±12.6	83	11	39	19	78	2.5
DCP011515DBP DCP011515DBP-U				±14.25	±15	±15.75	66 <sup>(2)</sup>	12	39	20	80	2.5
DCP012405BP DCP012405BP-U	21.6	24	26.4	4.75	5	5.25	200	13	23	14	77	2.5
DCP012415DBP DCP012415DBP-U				±14.25	±15	±15.75	66 <sup>(2)</sup>	10	35	17	76	3.8

(1) Load regulation =  $(V_{OUT} \text{ at } 10\% \text{ load} - V_{OUT} \text{ at } 100\%) / V_{OUT} \text{ at } 75\% \text{ load}$

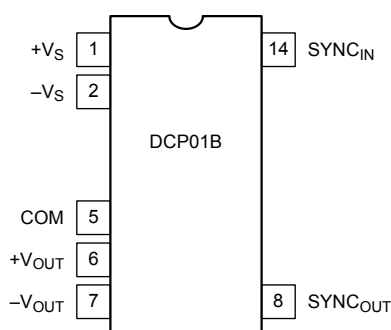
(2)  $I_{OUT1} + I_{OUT2}$

(3)  $P_{OUT(max)} = 1\text{ W}$

## 5 Pin Configuration and Functions



5-1. 7-Pin PDIP and SOP (Single Output) NVA and DUA Package (Top View)



5-2. 7-Pin PDIP and SOP (Dual Output) NVA and DUA Package (Top View)

### Pin Functions

PIN NAME	PIN NUMBER		I/O (1)	DESCRIPTION
	SINGLE-OUTPUT	DUAL-OUTPUT		
COM	—	5	O	Output side common
NC	7	—	—	No connection
SYNC <sub>IN</sub>	14	14	I	Synchronization. Synchronize multiple devices by connecting the SYNC pins of each. Pulling this pin low disables the internal oscillator.
SYNC <sub>OUT</sub>	8	8	O	Synchronization output. Unrectified transformer output
+V <sub>OUT</sub>	6	6	O	Positive output voltage
+V <sub>S</sub>	1	1	I	Input voltage
-V <sub>OUT</sub>	5	7	O	Negative output voltage
-V <sub>S</sub>	2	2	I	Input side common

(1) I = Input, O = Output

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

		MIN	MAX	UNIT
Input voltage	5-V input devices		7	V
	15-V input devices		18	
	24-V input devices		29	
Lead temperature (soldering, 10 s)			270	°C
Storage temperature, T <sub>stg</sub>		–60	125	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±1000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±250	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Input voltage	5-V input devices	4.5	5	5.5	V
	15-V input devices	13.5	15	16.5	
	24-V input devices	21.6	24	26.4	
Operating ambient temperature range, T <sub>A</sub>		–40		100	°C

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		DCP01B	DCP01B	UNIT
		NVA (PDIP)	DUA (SOP)	
		7 PINS	7 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	61	61	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	26	26	°C/W
R <sub>θJB</sub>	Junction-to-board thermal resistance	24	24	°C/W
ψ <sub>JT</sub>	Junction-to-top characterization parameter	7	7	°C/W
ψ <sub>JB</sub>	Junction-to-board characterization parameter	24	24	°C/W
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	N/A	N/A	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#), SPRA953.

## 6.5 Electrical Characteristics

at  $T_A = 25^\circ\text{C}$ ,  $+V_S = \text{nominal}$ ,  $C_{IN} = 2.2\ \mu\text{F}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$ , (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
OUTPUT						
P <sub>OUT</sub>	Output power	I <sub>LOAD</sub> = 100% (full load)			1	W
V <sub>RIPPLE</sub>	Output voltage ripple	C <sub>OUT</sub> = 1 μF, I <sub>LOAD</sub> = 50%		20		mV <sub>PP</sub>
Voltage vs. Temperature		−40°C ≤ T <sub>A</sub> ≤ 25°C		0.046		%/°C
		25°C ≤ T <sub>A</sub> ≤ 100°C		0.016		%/°C
INPUT						
V <sub>S</sub>	Input voltage range		−10%		10%	
ISOLATION						
V <sub>ISO</sub>	Isolation	1-second flash test	Voltage	1		kVrms
			dV/dt		500	V/s
			Leakage current		30	μA
		Continuous working voltage across isolation barrier	DC		60	VDC
			AC		42.5	VAC
LINE REGULATION						
V <sub>OUT</sub>	Output voltage	I <sub>OUT</sub> ≥ 10% load current and constant, V <sub>S</sub> (min) to V <sub>S</sub> (typ)		1%	15%	
		I <sub>OUT</sub> ≥ 10% load current and constant, V <sub>S</sub> (typ) to V <sub>S</sub> (max)		1%	15%	
RELIABILITY						
	Demonstrated	T <sub>A</sub> = 55°C		55		FITS
THERMAL SHUTDOWN						
T <sub>SD</sub>	Die temperature at shutdown			150		°C
I <sub>SD</sub>	Shutdown current			3		mA

## 6.6 Switching Characteristics

at  $T_A = +25^\circ\text{C}$ ,  $+V_S = \text{nominal}$ ,  $C_{IN} = 2.2\ \mu\text{F}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$ , (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$f_{OSC}$	Oscillator frequency	$f_{SW} = f_{OSC}/2$		800		kHz
$V_{IL}$	Low-level input voltage, SYNC		0		0.4	V
$I_{SYNC}$	Input current, SYNC	$V_{SYNC} = 2\ \text{V}$		75		$\mu\text{A}$
$t_{DISABLE}$	Disable time			2		$\mu\text{s}$
$C_{SYNC}$	Capacitance loading on SYNC pin <sup>(1)</sup>	External			3	pF

(1) The application report [External Synchronization of the DCP01/02 Series of DC/DC Converters](#) (SBAA035) describes this configuration.

## 6.7 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $V_{+VS} = \text{nominal}$ , (unless otherwise noted)

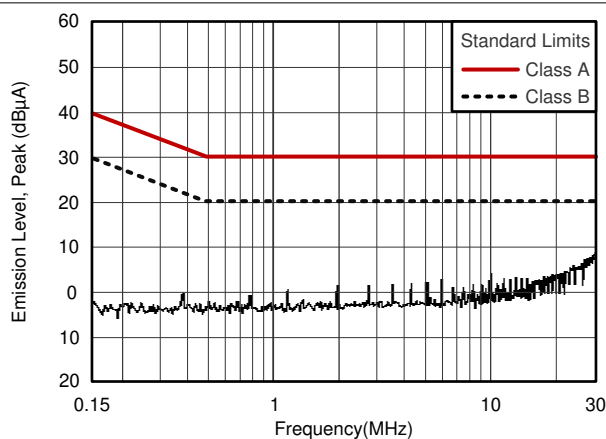


Figure 6-1. Conducted Emissions

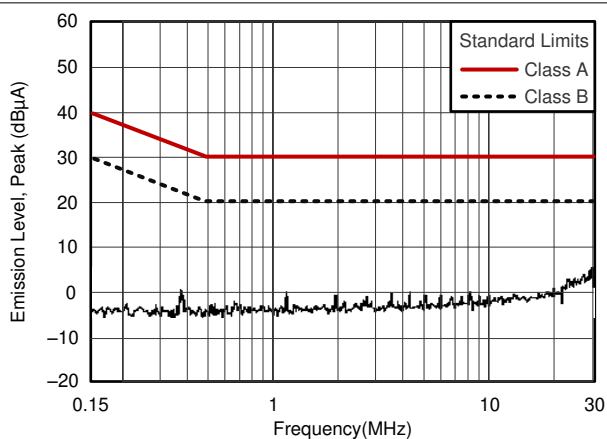


Figure 6-2. Conducted Emissions

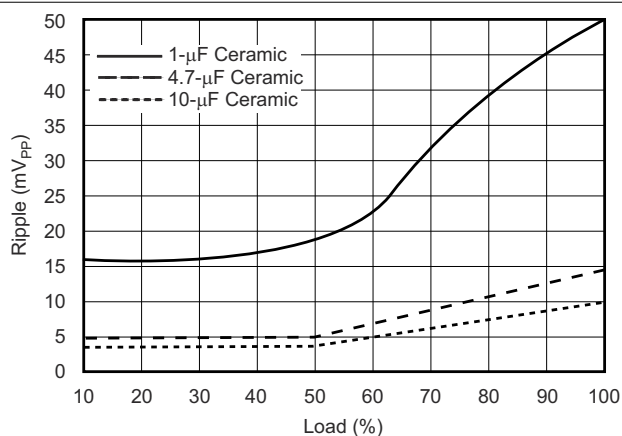


Figure 6-3. Output Ripple versus Load

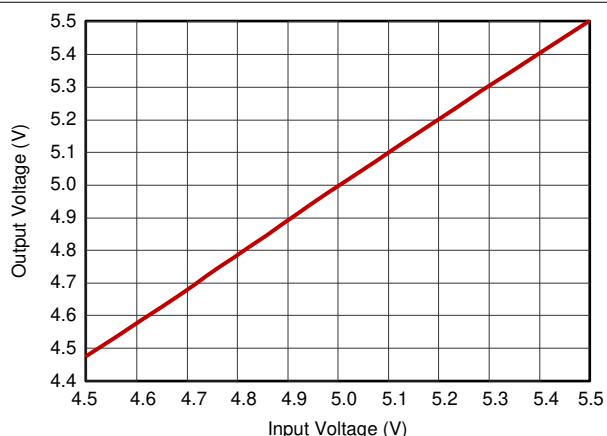
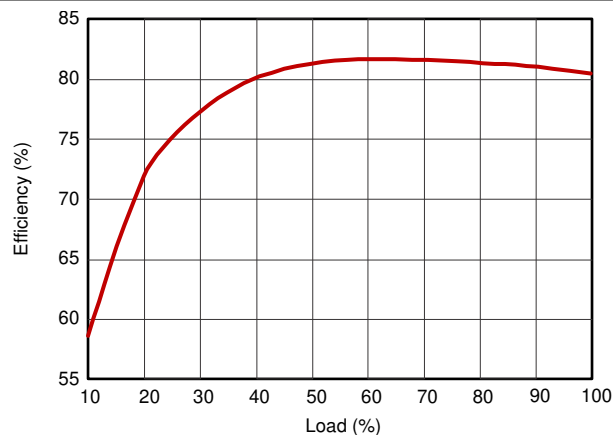
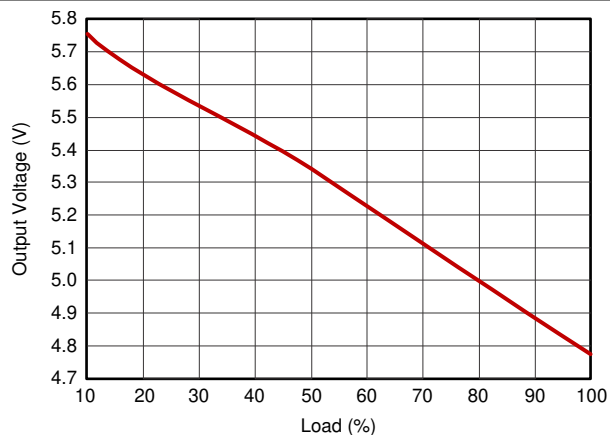


Figure 6-4. Line Regulation



DCP010505B

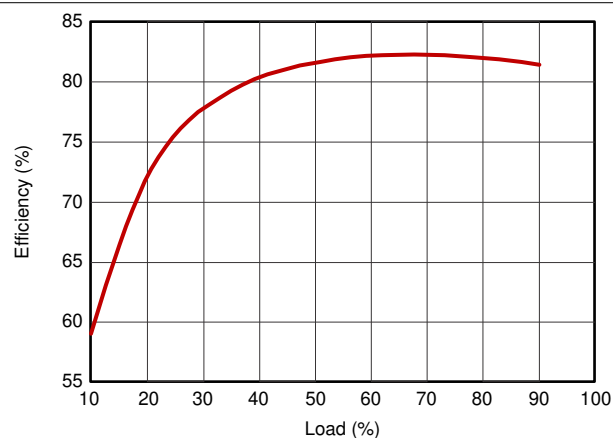
6-5. Efficiency versus Load



DCP010505B

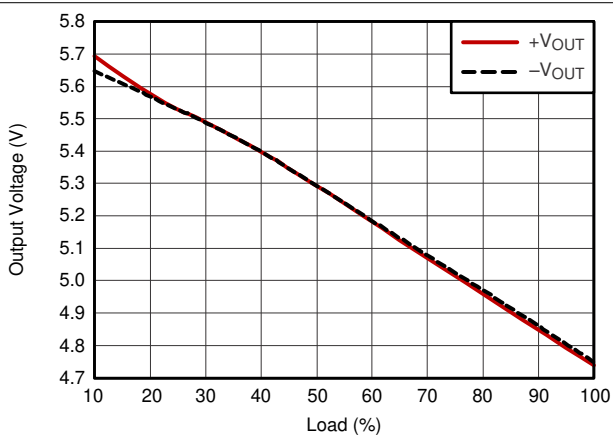
Note: Operations under 10% Load

6-6. Load Regulation



DCP010505DB

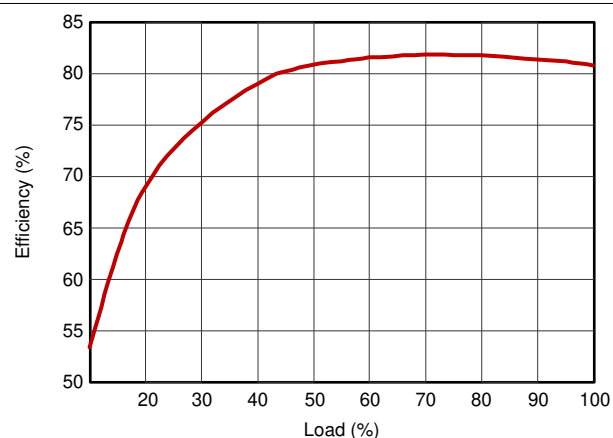
6-7. Efficiency versus Load



DCP010505DB

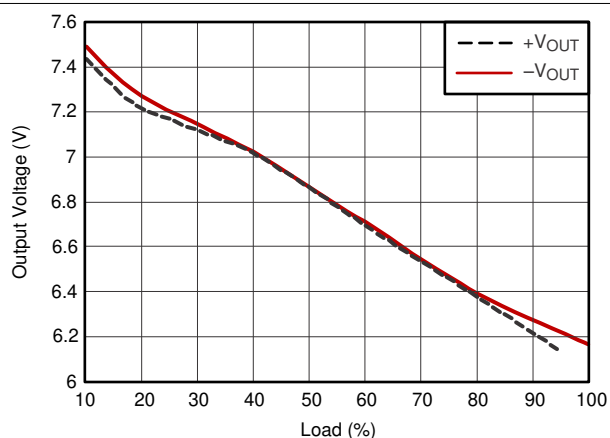
Note: Operations under 10% Load

6-8. Load Regulation



DCP010507DB

6-9. Efficiency versus Load

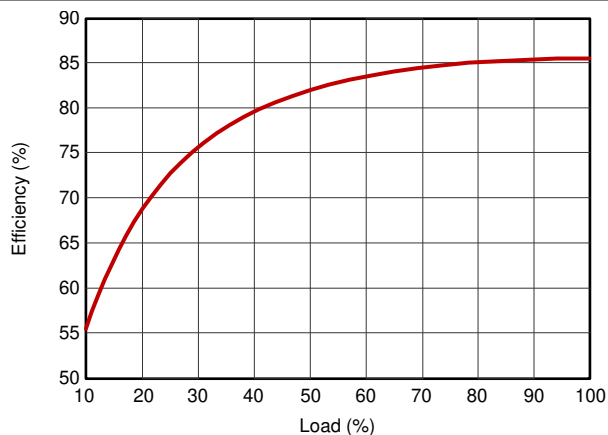


DCP010507DB

Note: Operations under 10% Load

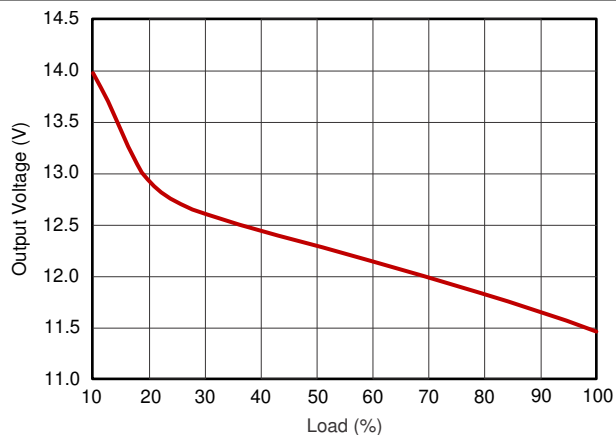
6-10. Load Regulation





DCP010512B

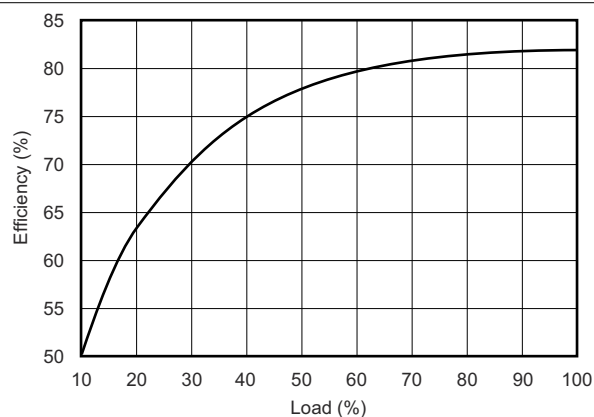
6-11. Efficiency versus Load



DCP010512B

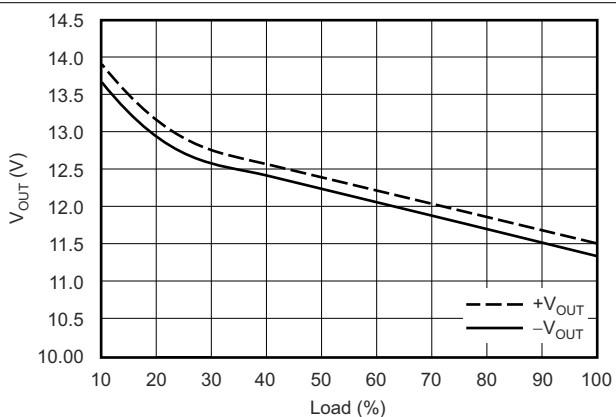
Note: Operations under 10% Load

6-12. Load Regulation



DCP010512DB

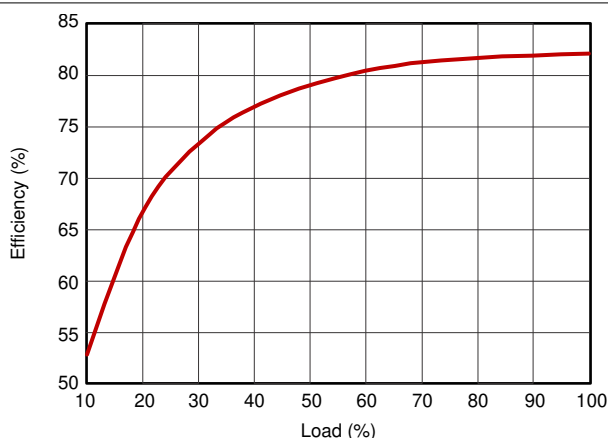
6-13. Efficiency versus Load



DCP010512DB

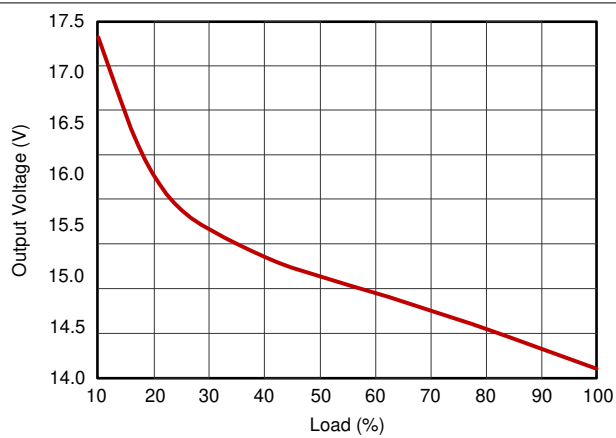
Note: Operations under 10% Load

6-14. Load Regulation



DCP010515B

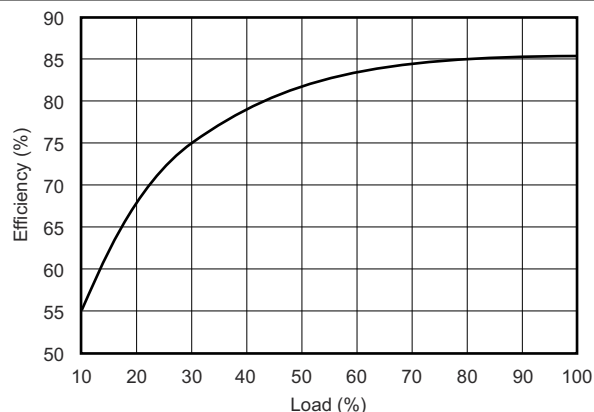
6-15. Efficiency versus Load



DCP010515B

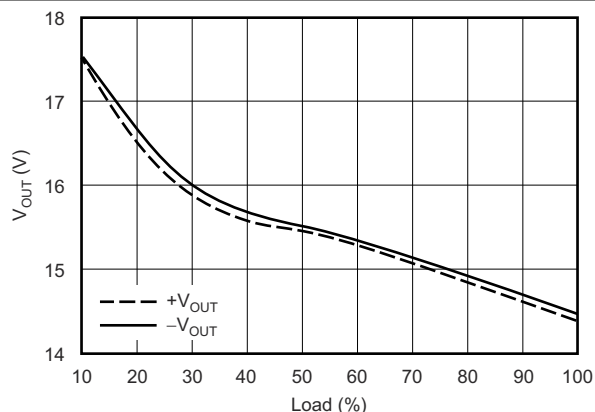
Note: Operations under 10% Load

6-16. Load Regulation



DCP010515DB

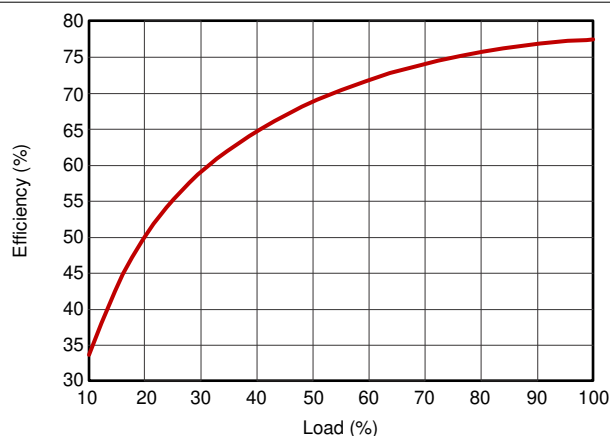
6-17. Efficiency versus Load



DCP010515DB

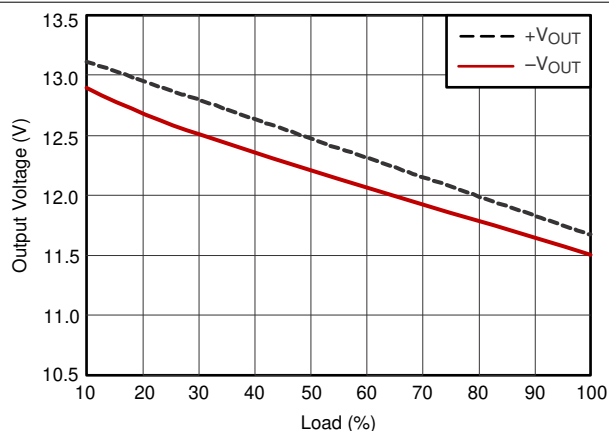
Note: Operations under 10% Load

6-18. Load Regulation



DCP011512DB

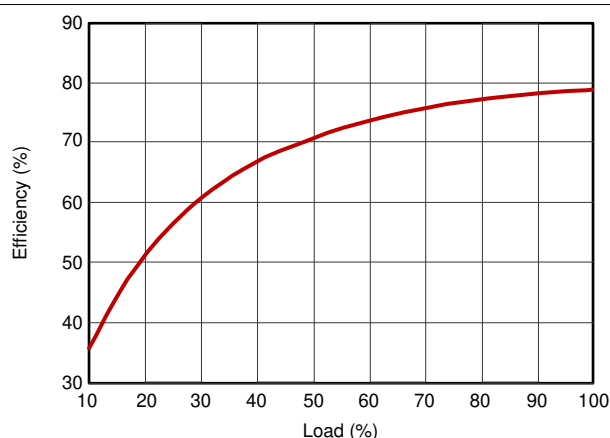
6-19. Efficiency versus Load



DCP011512DB

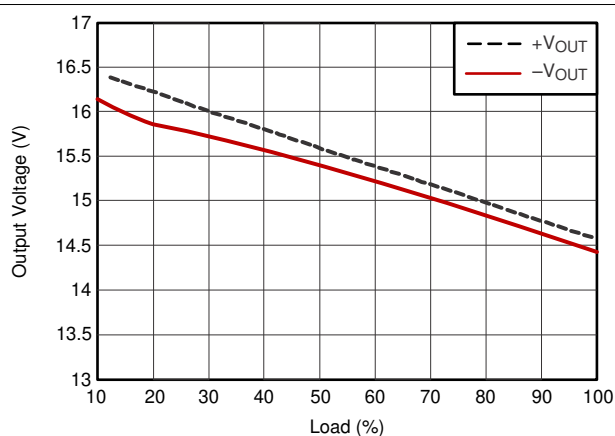
Note: Operations under 10% Load

6-20. Load Regulation



DCP011515DB

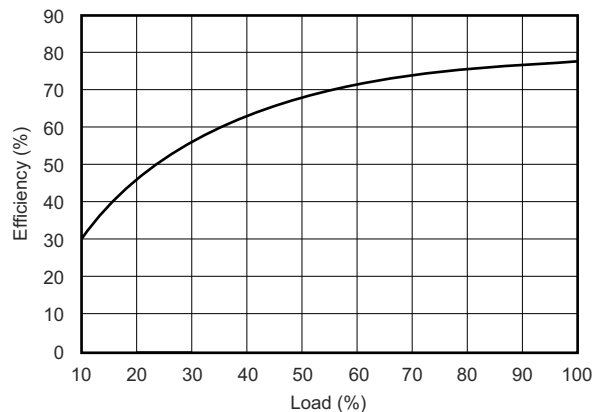
6-21. Efficiency versus Load



DCP011515DB

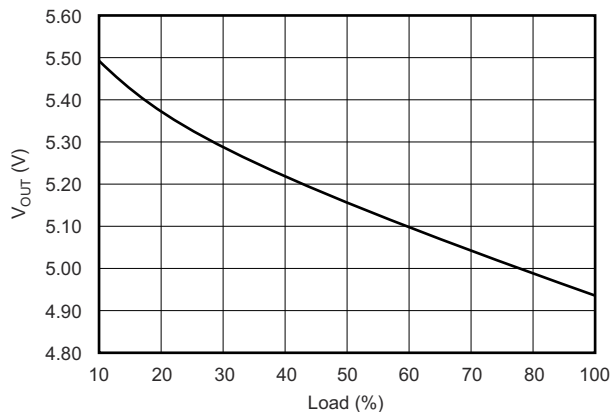
Note: Operations under 10% Load

6-22. Load Regulation



DCP012405B

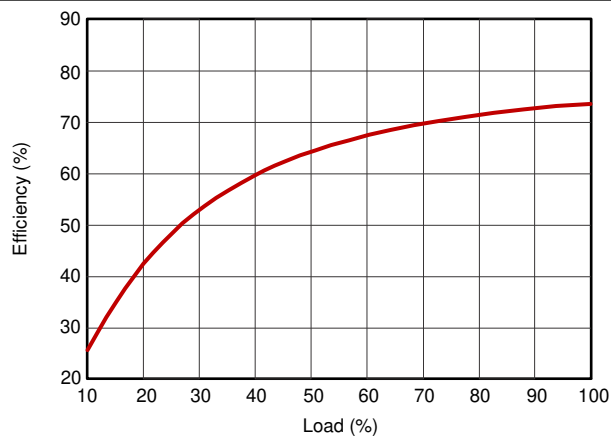
**6-23. Efficiency versus Load**



DCP012405B

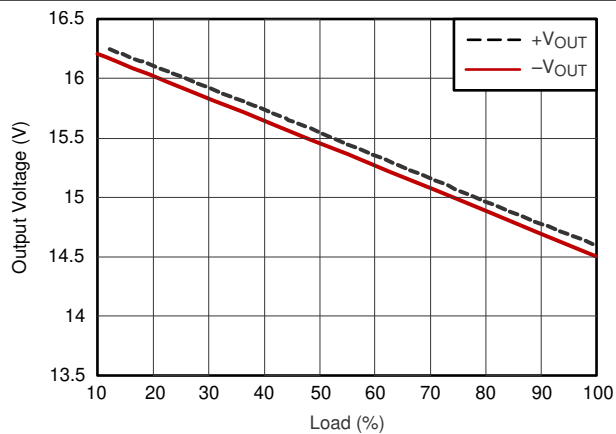
**Note:** Operations under 10% Load

**6-24. Load Regulation**



DCP012415DB

**6-25. Efficiency versus Load**



DCP012415DB

**Note:** Operations under 10% Load

**6-26. Load Regulation**

## 7 Detailed Description

### 7.1 Overview

The DCP01B offers up to 1 W of isolated, unregulated output power from a 5-V, 15-V, or 24-V input source with a typical efficiency of up to 85%. This efficiency is achieved through highly integrated packaging technology and the implementation of a custom power stage and control device. The DCP01B devices are specified for operational isolation only. The circuit design uses an advanced BiCMOS and DMOS process.

### 7.2 Functional Block Diagrams

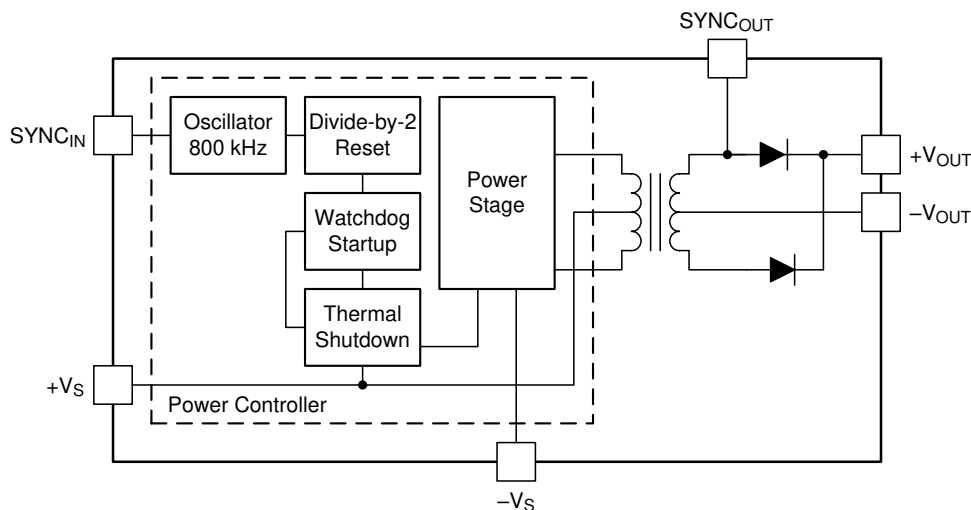


FIG 7-1. Single Output Device

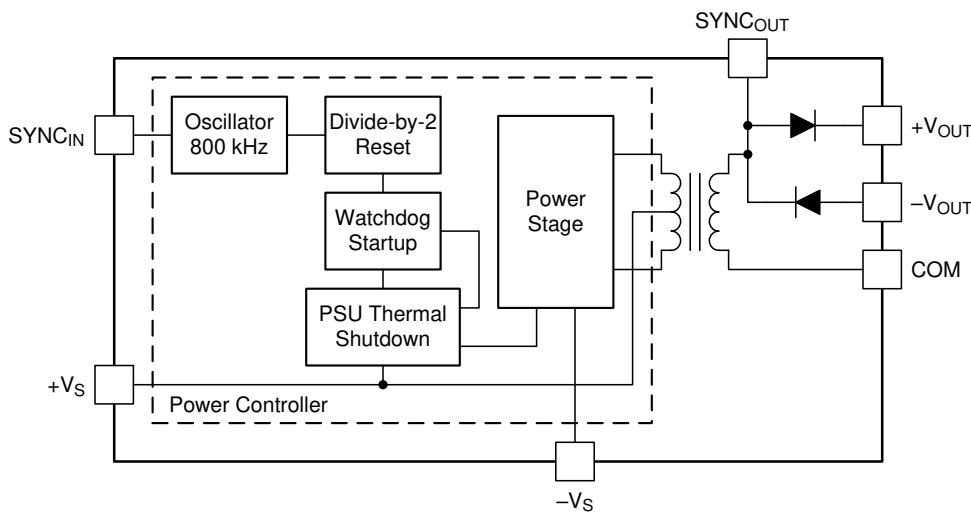


FIG 7-2. Dual Output Device

## 7.3 Feature Description

### 7.3.1 Isolation

Underwriters Laboratories, UL™ defines several classes of isolation that are used in modern power supplies.

*Safety extra low voltage* (SELV) is defined by UL (UL1950 E199929) as a secondary circuit which is so designated and protected that under normal and single fault conditions the voltage between any two accessible parts, or between an accessible part and the equipment earthing terminal for operational isolation does not exceed steady state 42.5 V peak or 60 V<sub>DC</sub> for more than one second.

#### 7.3.1.1 Operation or Functional Isolation

Operational or functional isolation is defined by the use of a high-potential (hipot) test only. Typically, this isolation is defined as the use of insulated wire in the construction of the transformer as the primary isolation barrier. The hipot one-second duration test (dielectric voltage, withstand test) is a production test used to verify that the isolation barrier is functioning. Products with operational isolation must never be used as an element in a safety-isolation system.

#### 7.3.1.2 Basic or Enhanced Isolation

Basic or enhanced isolation is defined by specified creepage and clearance limits between the primary and secondary circuits of the power supply. Basic isolation is the use of an isolation barrier in addition to the insulated wire in the construction of the transformer. Input and output circuits must also be physically separated by specified distances.

#### 7.3.1.3 Continuous Voltage

For a device that has no specific safety agency approvals (operational isolation), the continuous voltage that can be applied across the part in normal operation is less than 42.5 V<sub>RMS</sub>, or 60 V<sub>DC</sub>. Ensure that both input and output voltages maintain normal SELV limits. The isolation test voltage represents a measure of immunity to transient voltages.

#### WARNING

Do not use the device as an element of a safety isolation system that exceeds the SELV limit.

If the device is expected to function correctly with more than 42.5 V<sub>RMS</sub> or 60 V<sub>DC</sub> applied continuously across the isolation barrier, then the circuitry on both sides of the barrier must be regarded as operating at an unsafe voltage, and further isolation or insulation systems must form a barrier between these circuits and any user-accessible circuitry according to safety standard requirements.

#### 7.3.1.4 Isolation Voltage

The terms *Hipot test*, *flash-tested*, *withstand voltage*, *proof voltage*, *dielectric withstand voltage*, and *isolation test voltage* all describe a similar idea. They describe a test voltage applied for a specified time across a component designed to provide electrical isolation to verify the integrity of that isolation. TI's DCP01B series of DC/DC converters are all 100% production tested at 1.0 kV<sub>AC</sub> for one second.

#### 7.3.1.5 Repeated High-Voltage Isolation Testing

Repeated high-voltage isolation testing of a barrier component can degrade the isolation capability, depending on materials, construction, and environment. The DCP01B series of DC/DC converters have toroidal, enameled, wire isolation transformers with no additional insulation between the primary and secondary windings. While a device can be expected to withstand several times the stated test voltage, the isolation capability depends on the wire insulation. Any material, including this enamel (typically polyurethane), is susceptible to eventual chemical degradation when subject to very-high applied voltages. Therefore, strictly limit the number of high-voltage tests and repeated high-voltage isolation testing. However, if it is absolutely required, reduce the voltage by 20% from specified test voltage with a duration limit of one second per test.

### 7.3.2 Power Stage

The DCP01B series of devices uses a push-pull, center-tapped topology. The DCP01B devices switch at 400 kHz (divide-by-2 from an 800-kHz oscillator).

### 7.3.3 Oscillator And Watchdog Circuit

The onboard, 800-kHz oscillator generates the switching frequency by a divide-by-2 circuit. The oscillator can be synchronized to other DCP01B series device circuits or an external source, and is used to minimize system noise.

A watchdog circuit checks the operation of the oscillator circuit. The oscillator can be disabled by pulling the SYNC<sub>IN</sub> pin low. When the SYNC<sub>IN</sub> pin goes low, the output pins transition into tri-state mode, which occurs within 2 μs.

### 7.3.4 Thermal Shutdown

The DCP01B series of devices are protected by a thermal-shutdown circuit.

If the on-chip temperature rises above 150°C, the device shuts down. Normal operation resumes as soon as the temperature falls below 150°C. While the over temperature condition continues, operation randomly cycles on and off. This cycling continues until the temperature is reduced.

### 7.3.5 Synchronization

When more than one DC/DC converter is needed onboard, beat frequencies and other electrical interference can be generated. This interference occurs because of the small variations in switching frequencies between the DC/DC converters.

The DCP01B series of devices overcomes this interference by allowing devices to synchronize to one another. Synchronize up to eight devices by connecting the SYNC pins of each device, taking care to minimize the capacitance of tracking. Stray capacitance (greater than 3 pF) reduces the switching frequency, or can sometimes stop the oscillator circuit. The maximum recommended voltage applied to the SYNC pin is 3.0 V.

For an application that uses more than eight synchronized devices, use an external device to drive the SYNC pins. The application report [External Synchronization of the DCP01/02 Series of DC/DC Converters](#) describes this configuration.

#### Note

**During the start-up period, all synchronized devices draw maximum current from the input simultaneously. If the input voltage falls below approximately 4 V, the devices may not start up. A 2.2-μF capacitor should be connected close to each device input pin.**

### 7.3.6 Light Load Operation (< 10%)

Operation below 10% load can cause the output voltage to increase up to double the typical output voltage. For applications that operate less than 10% of rated output current, it is recommended to add a minimum load to ensure the output voltage of the device is within the load regulation range. For example, connect a 250-Ω pre-load resistor to meet the 10% minimum load condition for the DCP010505BP.

### 7.3.7 Load Regulation (10% to 100%)

The load regulation of the DCP01B series of devices is specified at 10% to 100% load. Placing a minimum 10% load will ensure the output voltage is within the range specified in [セクション 6.5](#). For more information regarding operation below 10% load, see [セクション 7.3.6](#).

### 7.3.8 Construction

The basic construction of the DCP01B series of devices is the same as standard integrated circuits. The molded package contains no substrate. The DCP01B series of devices are constructed using an IC, rectifier diodes, and a wound magnetic toroid on a lead frame. Because the package contains no solder, the devices do not require any special printed circuit board (PCB) assembly processing. This architecture results in an isolated DC/DC converter with inherently high reliability.

### 7.3.9 Thermal Management

Due to the high power density of these devices, it is advisable to provide ground planes on the input and output rails.

### 7.3.10 Power-Up Characteristics

The DCP01B series of devices do not include a soft-start feature. Therefore, a high in-rush current during power up is expected. Refer to the [DCPA1 series](#) of devices for a 1-W, isolated, unregulated DC/DC converter module with soft start included. [Figure 7-3](#) shows the typical start-up waveform for a DCP010505BP, operating from a 5-V input with no load on the output. [Figure 7-4](#) shows the start-up waveform for a DCP010505BP starting up into a 10% load. [Figure 7-5](#) shows the start-up waveform starting up into a full (100%) load.

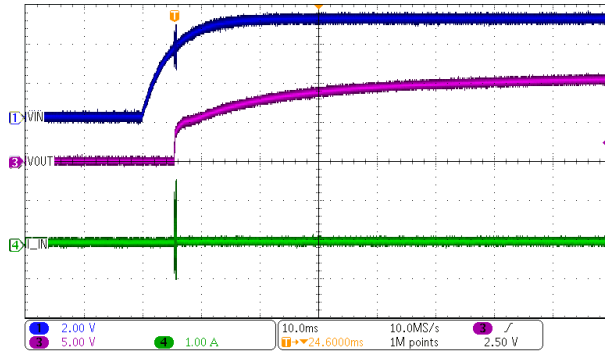


图 7-3. DCP010505BP Start-Up at No Load

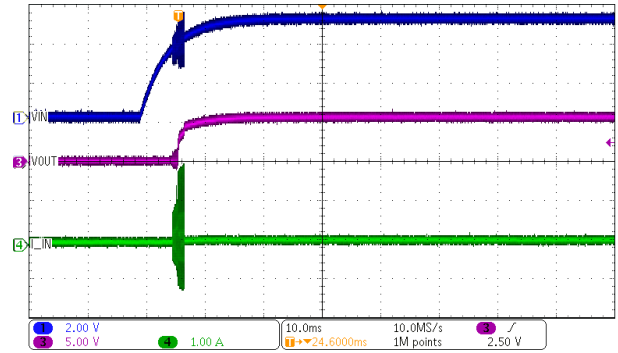


图 7-4. DCP010505BP Start-Up at 10% Load

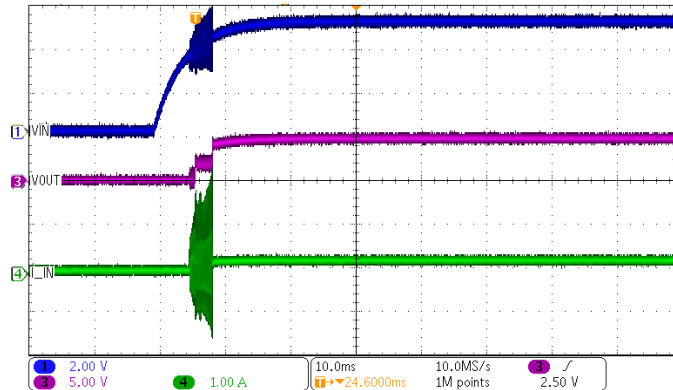


图 7-5. DCP010505BP Start-Up at 100% Load

## 7.4 Device Functional Modes

### 7.4.1 Disable and Enable (SYNC<sub>IN</sub> Pin)

Each of the DCP01B series devices can be disabled or enabled by driving the SYNC<sub>IN</sub> pin using an open-drain CMOS gate. If the SYNC<sub>IN</sub> pin is pulled low, the DCP01B becomes disabled. The disable time depends upon the external loading. The internal disable function is implemented within 2  $\mu$ s. Removal of the pulldown causes the DCP01B to be enabled.

Capacitive loading on the SYNC<sub>IN</sub> pin must be minimized ( $\leq 3$  pF) to prevent a reduction in the oscillator frequency. The application report [External Synchronization of the DCP01/02 Series of DC/DC Converters](#) describes disable and enable control circuitry.

### 7.4.2 Decoupling

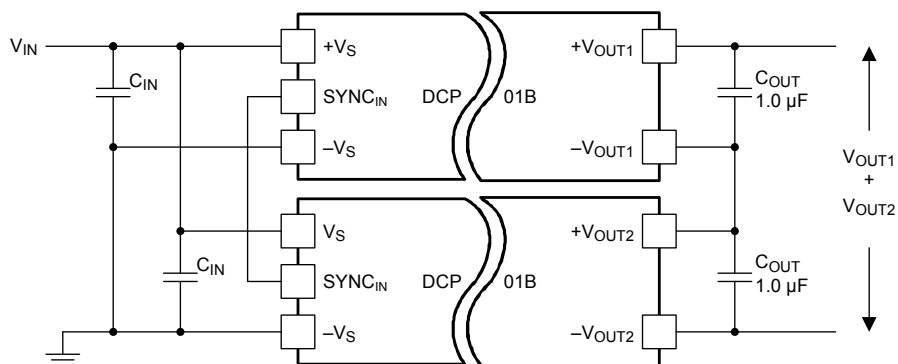
#### 7.4.2.1 Ripple Reduction

The high switching frequency of 400 kHz allows simple filtering. To reduce ripple, it is recommended that a minimum of 1- $\mu$ F capacitor be used on the +V<sub>OUT</sub> pin. For dual output devices, decouple both of the outputs to the COM pin. The required 2.2- $\mu$ F, low ESR ceramic input capacitor also helps reduce ripple and noise, (24-V input voltage versions require only 0.47  $\mu$ F of input capacitance). See application report [DC-to-DC Converter Noise Reduction](#).

#### 7.4.2.2 Connecting the DCP01B in Series

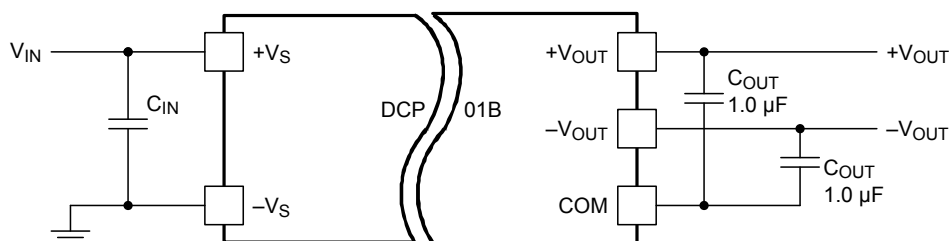
Multiple DCP01B isolated 1-W DC/DC converters can be connected in series to provide non-standard voltage rails. This configuration is possible by using the floating outputs provided by the galvanic isolation of the DCP01.

Connect the +V<sub>OUT</sub> from one DCP01B to the -V<sub>OUT</sub> of another (see [Figure 7-6](#)). If the SYNC<sub>IN</sub> pins are tied together, the self-synchronization feature of the DCP01B prevents beat frequencies on the voltage rails. The synchronization feature of the DCP01B allows easy series connection without external filtering, thus minimizing cost.



**Figure 7-6. Multiple DCP01B Devices Connected in Series**

The outputs of a dual-output DCP01B can also be connected in series to provide two times the magnitude of +V<sub>OUT</sub>, as shown in [Figure 7-7](#). For example, connect a dual-output, 15-V, DCP012415DB device to provide a 30-V rail.

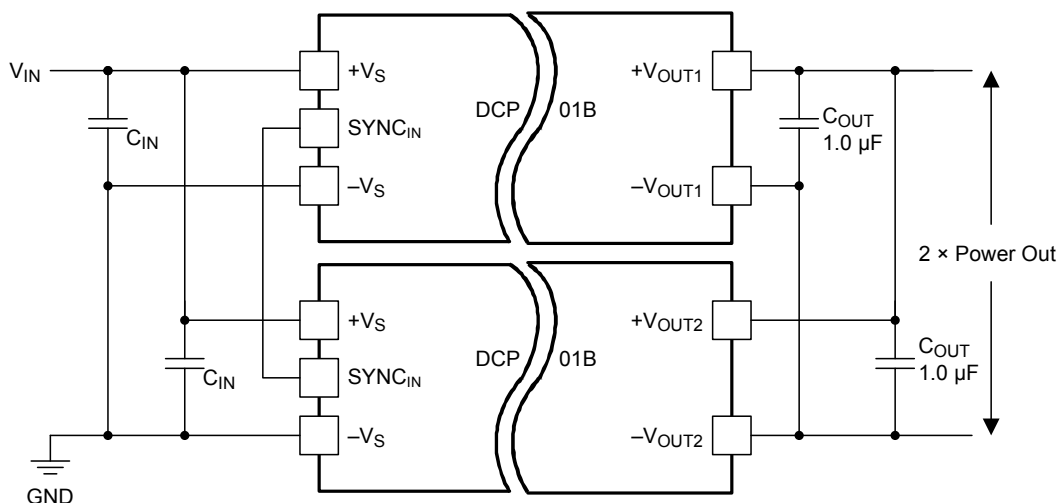


**Figure 7-7. Dual Output Devices Connected in Series**



### 7.4.2.3 Connecting the DCP01B in Parallel

If the output power from one DCP01B is not sufficient, it is possible to parallel the outputs of multiple DCP01Bs, as shown in [Figure 7-8](#) (applies to single output devices only). The synchronization feature allows easy synchronization to prevent power-rail beat frequencies at no additional filtering cost.



**Figure 7-8. Multiple DCP01B Devices Connected in Parallel**

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.2 Typical Application

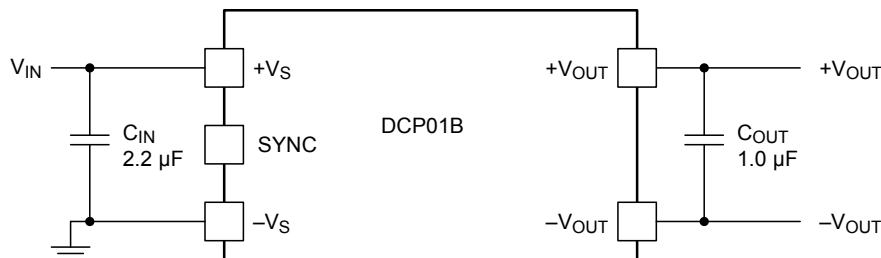


图 8-1. Typical DCP010505 Application

#### 8.2.1 Design Requirements

For this design example, use the parameters listed in 表 8-1 and follow the design procedures shown in the セクション 8.2.2.

表 8-1. Design Example Parameters

PARAMETER		VALUE	UNIT
$V_{(+VS)}$	Input voltage	5	V
$V_{(+VOUT)}$	Output voltage	5	V
$I_{OUT}$	Output current rating	200	mA
$f_{SW}$	Operating frequency	400	kHz

#### 8.2.2 Detailed Design Procedure

##### 8.2.2.1 Input Capacitor

For all 5-V and 15-V input voltage designs, select a 2.2-μF low-ESR ceramic input capacitor to ensure a good startup performance. 24-V input applications require only 0.47-μF of input capacitance.

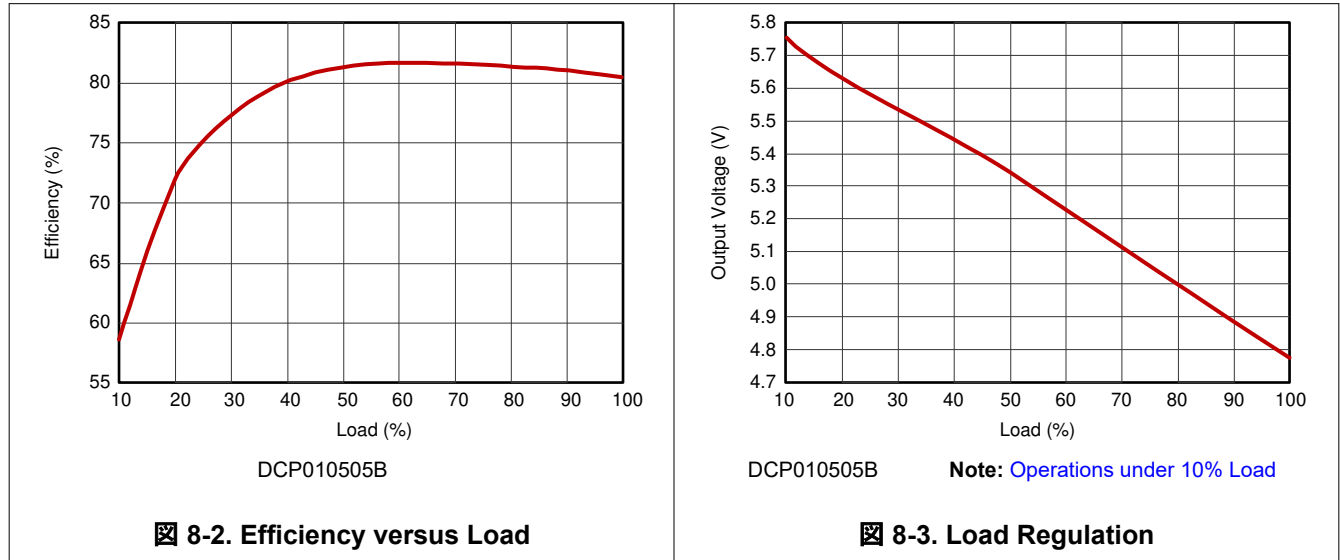
##### 8.2.2.2 Output Capacitor

For any DCP01B design, select a 1.0-μF low-ESR ceramic output capacitor to reduce output ripple.

##### 8.2.2.3 SYNC<sub>IN</sub> Pin

In a stand-alone application, leave the SYNC<sub>IN</sub> pin floating.

### 8.2.3 DCP010505 Application Curves

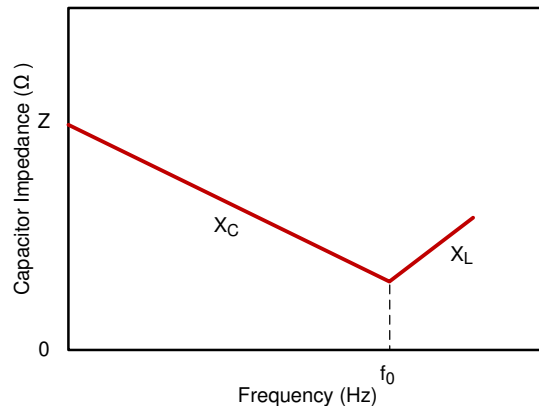


### 8.2.4 PCB Design

The copper losses (resistance and inductance) can be minimized by the use of mutual ground and power planes (tracks) where possible. If that is not possible, use wide tracks to reduce the losses. If several devices are being powered from a common power source, a star-connected system for the track must be deployed. Do not connect the devices in series, because that type of connection cascades the resistive losses. The position of the decoupling capacitors is important. They must be as close to the devices as possible in order to reduce losses. See [セクション 10](#) for more details.

### 8.2.5 Decoupling Ceramic Capacitors

All capacitors have losses because of internal equivalent series resistance (ESR), and to a lesser degree, equivalent series inductance (ESL). Values for ESL are not always easy to obtain. However, some manufacturers provide graphs of frequency versus capacitor impedance. These graphs typically show the capacitor impedance falling as frequency is increased (as shown in [Figure 8-4](#)). In [Figure 8-4](#),  $X_C$  is the reactance due to the capacitance,  $X_L$  is the reactance due to the ESL, and  $f_0$  is the resonant frequency. As the frequency increases, the impedance stops decreasing and begins to rise. The point of minimum impedance indicates the resonant frequency of the capacitor. This frequency is where the components of capacitance and inductance reactance are of equal magnitude. Beyond this point, the capacitor is not effective as a capacitor.



**Figure 8-4. Capacitor Impedance versus Frequency**

However, there is a  $180^\circ$  phase difference resulting in cancellation of the imaginary component. The resulting effect is that the impedance at the resonant point is the real part of the complex impedance, namely, the value of the ESR. The output capacitor's resonant frequency must be higher than the default switching frequency (800 kHz) of the device to properly decouple noise at and below the switching frequency.

The effect of the ESR is to cause a voltage drop within the capacitor. The value of this voltage drop is simply the product of the ESR and the transient load current, as shown in 式 1.

$$V_{IN} = V_{PK} - (ESR \times I_{TR}) \quad (1)$$

where

- $V_{IN}$  is the voltage at the device input
- $V_{PK}$  is the maximum value of the voltage on the capacitor during charge
- $I_{TR}$  is the transient load current

The other factor that affects the performance is the value of the capacitance. However, for the input and the full wave outputs (single-output voltage devices), ESR is the dominant factor.

### 8.2.6 Input Capacitor and the Effects of ESR

If the input decoupling capacitor is not ceramic (and has an ESR greater than 20 mΩ), then at the instant the power transistors switch on, the voltage at the input pins falls momentarily. If the voltage falls below approximately 4 V, the device detects an undervoltage condition and switches the internal drive circuits to a momentary off state. This detection is carried out as a precaution against a genuine low input voltage condition that could slow down or even stop the internal circuits from operating correctly. A slow-down or stoppage results in the drive transistors being turned on too long, causing saturation of the transformer and destruction of the device.

Following detection of a low input voltage condition, the device switches off the internal drive circuits until the input voltage returns to a safe value, at which time the device tries to restart. If the input capacitor is still unable to maintain the input voltage, shutdown recurs. This process repeats until the input capacitor charges sufficiently to start the device correctly.

Normal start-up should occur in approximately 1 ms after power is applied to the device. If a considerably longer start-up duration time is encountered, it is likely that either (or both) the input supply or the capacitors are not performing adequately.

For 5-V to 15-V input devices, a 2.2-μF, low-ESR ceramic capacitor ensures good startup performance. For 24-V input voltage devices, 0.47-μF ceramic capacitors are recommended. Tantalum capacitors are not recommended, since most do not have low-ESR values and will degrade performance. If tantalum capacitors must be used, close attention must be paid to both the ESR and voltage as derated by the vendor.

#### Note

**During the start-up period, these devices may draw maximum current from the input supply. If the input voltage falls below approximately 4 V, the devices may not start up. Connect a 2.2-μF ceramic capacitor close to the input pins.**

### 8.2.7 Ripple and Noise

A good quality, low-ESR ceramic capacitor placed as close as practical across the input reduces reflected ripple and ensures a smooth start-up.

A good quality, low-ESR ceramic capacitor placed as close as practical across the rectifier output terminal and output ground gives the best ripple and noise performance. See application report [DC-to-DC Converter Noise Reduction](#) for more information on noise rejection.

#### 8.2.7.1 Output Ripple Calculation Example

The following example shows that increasing the capacitance has a much smaller effect on the output ripple voltage than does reducing the value of the ESR for the filter capacitor.

To calculate the output ripple for a DCP010505 device:

- $V_{OUT} = 5 \text{ V}$
- $I_{OUT} = 0.2 \text{ A}$

- At full output power, the load resistor is 25  $\Omega$
- Ceramic output capacitor of 1  $\mu\text{F}$ , ESR of 0.1  $\Omega$
- Capacitor discharge time 1% of 800 kHz (ripple frequency)

$$t_{\text{DIS}} = 0.0125 \mu\text{s}$$

$$\tau = C \times R_{\text{LOAD}}$$

$$\tau = 1 \times 10^{-6} \times 12.5 = 12.5 \mu\text{s}$$

$$V_{\text{DIS}} = V_{\text{O}}(1 - \text{EXP}(-t_{\text{DIS}} / \tau))$$

$$V_{\text{DIS}} = 5 \text{ mV}$$

By contrast, the voltage dropped because of ESR:

$$V_{\text{ESR}} = I_{\text{LOAD}} \times \text{ESR}$$

$$V_{\text{ESR}} = 20 \text{ mV}$$

$$\text{Ripple voltage} = 25 \text{ mV}$$

### 8.2.8 Dual DCP01B Output Voltage

The voltage output for dual DCP01B devices is half wave rectified; therefore, the discharge time is 1.25  $\mu\text{s}$ . Repeating the above calculations using the 100% load resistance of 50  $\Omega$  (0.1 A per output), the results are:

$$\tau = 25 \mu\text{s}$$

$$t_{\text{DIS}} = 1.25 \mu\text{s}$$

$$V_{\text{DIS}} = 244 \text{ mV}$$

$$V_{\text{ESR}} = 10 \text{ mV}$$

$$\text{Ripple Voltage} = 133 \text{ mV}$$

This time, it is the capacitor discharging that contributes to the largest component of ripple. Changing the output filter to 10  $\mu\text{F}$ , and repeating the calculations, the result is:

$$\text{Ripple voltage} = 25 \text{ mV}$$

This value is composed of almost equal components.

The previous calculations are offered as a guideline only. Capacitor parameters usually have large tolerances and can be susceptible to environmental conditions.

### 8.2.9 Optimizing Performance

Optimum performance can only be achieved if the device is correctly supported. The very nature of a switching converter requires power to be instantly available when it switches on. If the converter has DMOS switching transistors, the fast edges will create a high current demand on the input supply. This transient load placed on the input is supplied by the external input decoupling capacitor, thus maintaining the input voltage. Therefore, the input supply does not see this transient (this is an analogy to high-speed digital circuits). The positioning of the capacitor is critical and must be placed as close as possible to the input pins and connected via a low-impedance path.

The optimum performance primarily depends on two factors:

- Connection of the input and output circuits for minimal loss.
- The ability of the decoupling capacitors to maintain the input and output voltages at a constant level.

## 9 Power Supply Recommendations

The DCP01B is a switching power supply, and as such can place high peak current demands on the input supply. To avoid the supply falling momentarily during the fast switching pulses, ground and power planes must be used to connect the power to the input of DCP01 device. If this connection is not possible, then the supplies must be connected in a star formation with the traces made as wide as possible.

## 10 Layout

### 10.1 Layout Guidelines

Due to the high power density of these devices, provide ground planes on the input and output rails.

Figure 10-1 and Figure 10-2 show the schematic for the two DIP through-hole packages, and two SOP surface-mount packages for the DCP family of products which include DCP01B, DCP02, DCP01, DCR01, and DCR02. Figure 10-3 and Figure 10-4 illustrate a printed circuit board (PCB) layout for the schematics.

Including input power and ground planes provides a low-impedance path for the input power. For the output, the COM signal connects via a ground plane, while the connections for the positive and negative voltage outputs conduct via wide traces in order to minimize losses.

The output should be taken from the device using ground and power planes, thereby ensuring minimum losses.

The location of the decoupling capacitors in close proximity to their respective pins ensures low losses due to the effects of stray inductance, thus improving the ripple performance. This location is of particular importance to the input decoupling capacitor, because this capacitor supplies the transient current associated with the fast switching waveforms of the power drive circuits.

Allow the unused SYNC pin, to remain configured as a floating pad. It is advisable to place a guard ring (connected to input ground) or annulus connected around this pin to avoid any noise pick up. When connecting a SYNC pin to one or more SYNC design the linking trace to be short and narrow to avoid stray capacitance. Ensure that no other trace is in close proximity to this trace SYNC trace to decrease the stray capacitance on this pin. The stray capacitance affects the performance of the oscillator.

### 10.2 Layout Example

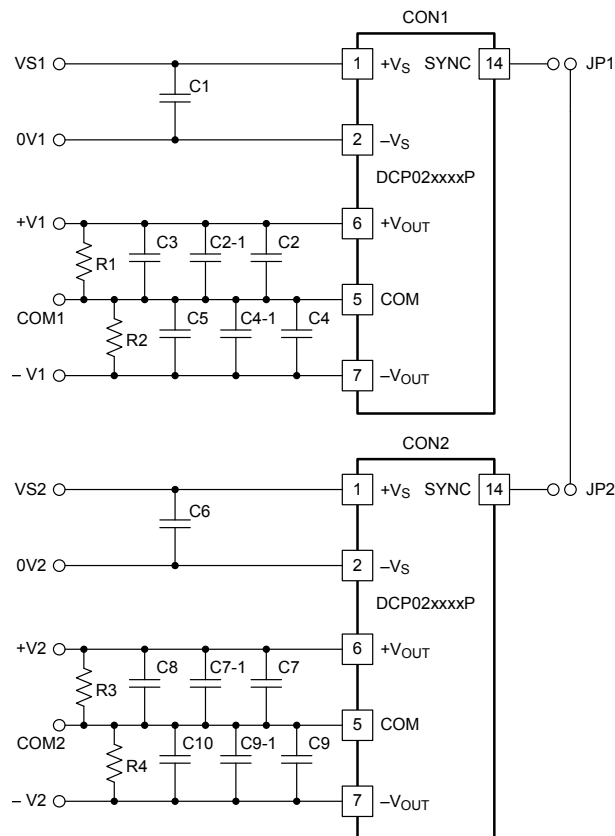


Figure 10-1. PCB Schematic, P Package

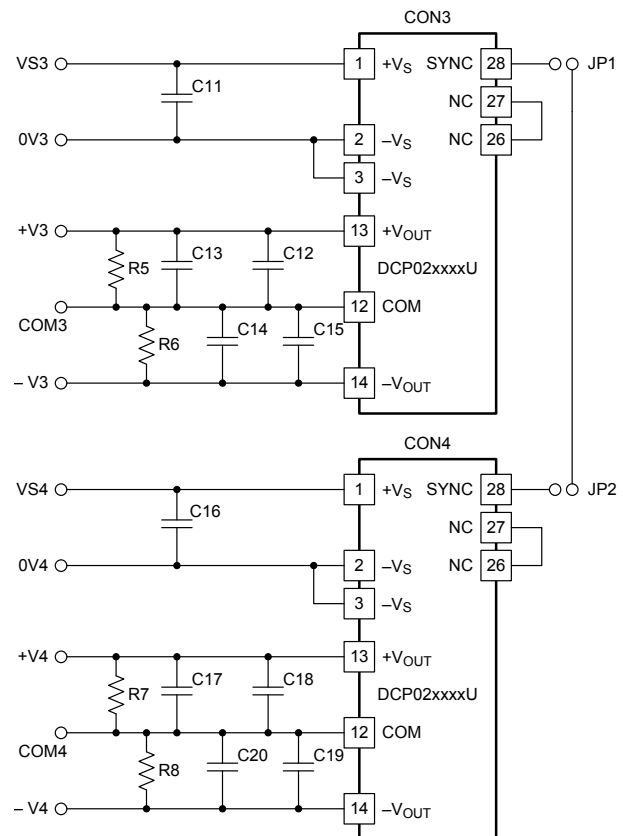
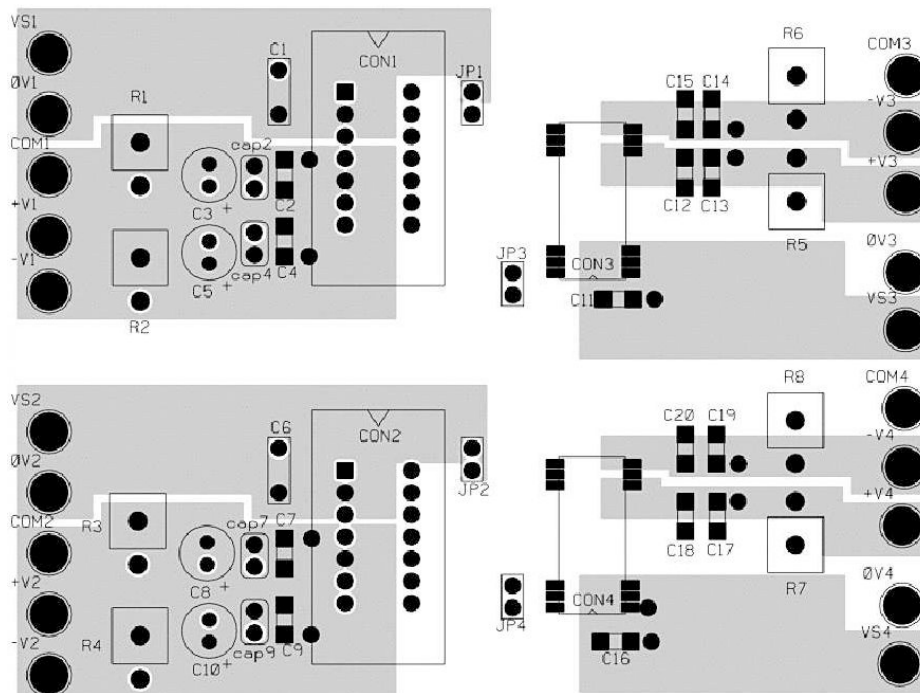
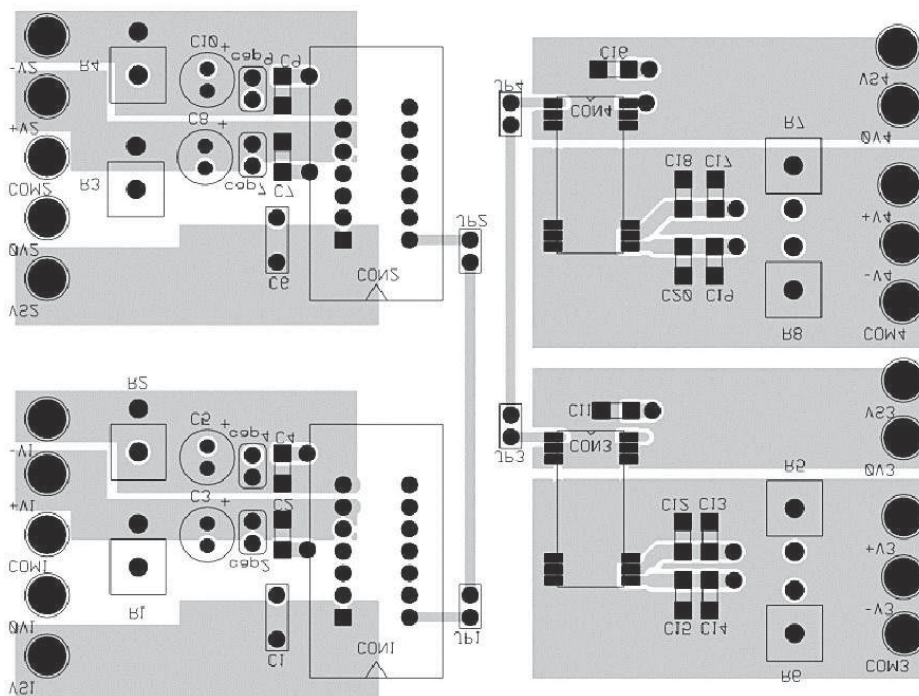


Figure 10-2. PCB Schematic, U Package



10-3. PCB Layout Example, Component-Side View



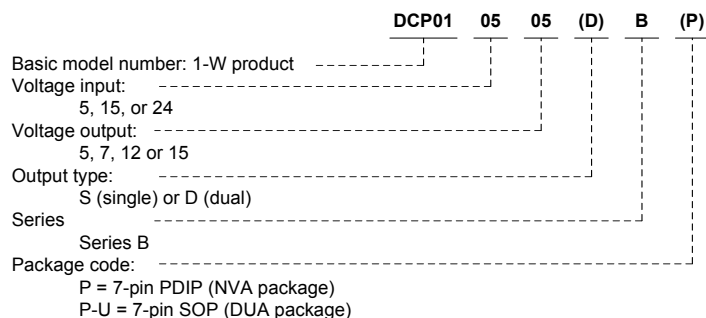
10-4. PCB Layout Example, Non-Component-Side View



## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Device Nomenclature



#### ✉ 11-1. Supplemental Ordering Information

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

- [DC-to-DC Converter Noise Reduction](#)
- [External Synchronization of the DCP01/02 Series of DC/DC Converters](#)
- [Optimizing Performance of the DCP01/02 Series of DC/DC Converters](#)

### 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.4 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

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### 11.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

### 11.7 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">DCP010505BP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505BP
<a href="#">DCP010505BP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
DCP010505BP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
<a href="#">DCP010505BP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
DCP010505BP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
DCP010505BP-U/7E4	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
DCP010505BP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505BP-U
DCP010505BP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505BP
DCP010505BPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505BP
DCP010505BPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505BP
<a href="#">DCP010505DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505DBP
<a href="#">DCP010505DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
DCP010505DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
<a href="#">DCP010505DBP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
DCP010505DBP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
DCP010505DBP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
DCP010505DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010505DBP-U
DCP010505DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010505DBP
<a href="#">DCP010507DBP-U/7E4</a>	Active	Production	SOP (DUA)   7	700   SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010507DBP-U
DCP010507DBP-U/7E4.B	Active	Production	SOP (DUA)   7	700   SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010507DBP-U
<a href="#">DCP010507DBP-UE4</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010507DBP-U
DCP010507DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010507DBP-U
<a href="#">DCP010507DBPE4</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010507DBP
DCP010507DBPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010507DBP
<a href="#">DCP010512BP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512BP
<a href="#">DCP010512BP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U
DCP010512BP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U
<a href="#">DCP010512BP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U
DCP010512BP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
DCP010512BP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U
DCP010512BP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512BP-U
DCP010512BP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512BP
DCP010512BPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512BP
DCP010512BPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512BP
<a href="#">DCP010512DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512DBP
<a href="#">DCP010512DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
DCP010512DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
<a href="#">DCP010512DBP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
DCP010512DBP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
DCP010512DBP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
DCP010512DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010512DBP-U
DCP010512DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512DBP
DCP010512DBPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010512DBP
<a href="#">DCP010515BP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515BP
<a href="#">DCP010515BP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
DCP010515BP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
<a href="#">DCP010515BP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
DCP010515BP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
DCP010515BP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515BP
DCP010515BPU/700E4	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
DCP010515BPU/700E4.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515BP-U
<a href="#">DCP010515DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515DBP
<a href="#">DCP010515DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
DCP010515DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
<a href="#">DCP010515DBP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
DCP010515DBP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
DCP010515DBP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
DCP010515DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP010515DBP-U
DCP010515DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515DBP
DCP010515DBPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515DBP

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
DCP010515DBPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP010515DBP
<a href="#">DCP011512DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011512DBP
<a href="#">DCP011512DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011512DBP-U
DCP011512DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011512DBP-U
DCP011512DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011512DBP
DCP011512DBPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011512DBP
DCP011512DBPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011512DBP
<a href="#">DCP011515DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011515DBP
<a href="#">DCP011515DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
DCP011515DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
<a href="#">DCP011515DBP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
DCP011515DBP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
DCP011515DBP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
DCP011515DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP011515DBP-U
DCP011515DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011515DBP
DCP011515DBPE4	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011515DBP
DCP011515DBPE4.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP011515DBP
<a href="#">DCP012405BP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP012405BP
<a href="#">DCP012405BP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012405BP-U
DCP012405BP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012405BP-U
DCP012405BP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP012405BP
<a href="#">DCP012415DBP</a>	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP012415DBP
<a href="#">DCP012415DBP-U</a>	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
DCP012415DBP-U.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
<a href="#">DCP012415DBP-U/700</a>	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
DCP012415DBP-U/700.B	Active	Production	SOP (DUA)   7	700   LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
DCP012415DBP-UE4	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
DCP012415DBP-UE4.B	Active	Production	SOP (DUA)   7	25   TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 100	DCP012415DBP-U
DCP012415DBP.B	Active	Production	PDIP (NVA)   7	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 100	DCP012415DBP

(1) **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TUBE



\*All dimensions are nominal

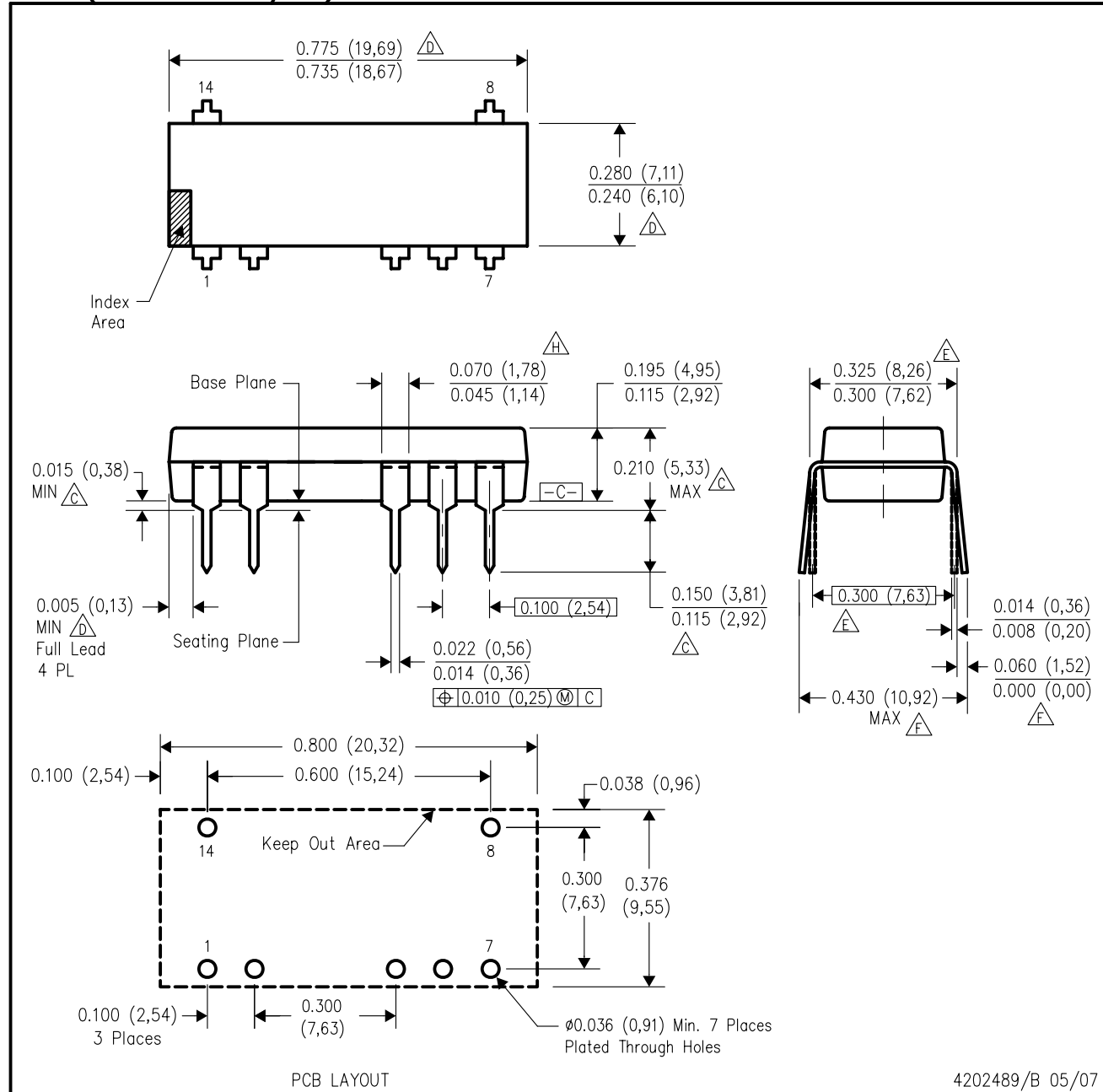
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
DCP010505BP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010505BP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010505BPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010505BPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010505DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010505DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010507DBPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010507DBPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512BP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512BP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512BPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512BPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010512DBPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515BP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515BP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515DBPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP010515DBPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011512DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011512DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011512DBPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011512DBPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011515DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011515DBP-U	DUA	SOP	7	25	532.13	13.51	7.36	6.91
DCP011515DBP-U.B	DUA	SOP	7	25	532.13	13.51	7.36	6.91
DCP011515DBP-UE4	DUA	SOP	7	25	532.13	13.51	7.36	6.91

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Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
DCP011515DBP-UE4.B	DUA	SOP	7	25	532.13	13.51	7.36	6.91
DCP011515DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011515DBPE4	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP011515DBPE4.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP012405BP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP012405BP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP012415DBP	NVA	PDIP	7	25	533.4	14.33	13.03	8.07
DCP012415DBP.B	NVA	PDIP	7	25	533.4	14.33	13.03	8.07

NVA (R-PDIP-T7/14)

PLASTIC DUAL-IN-LINE



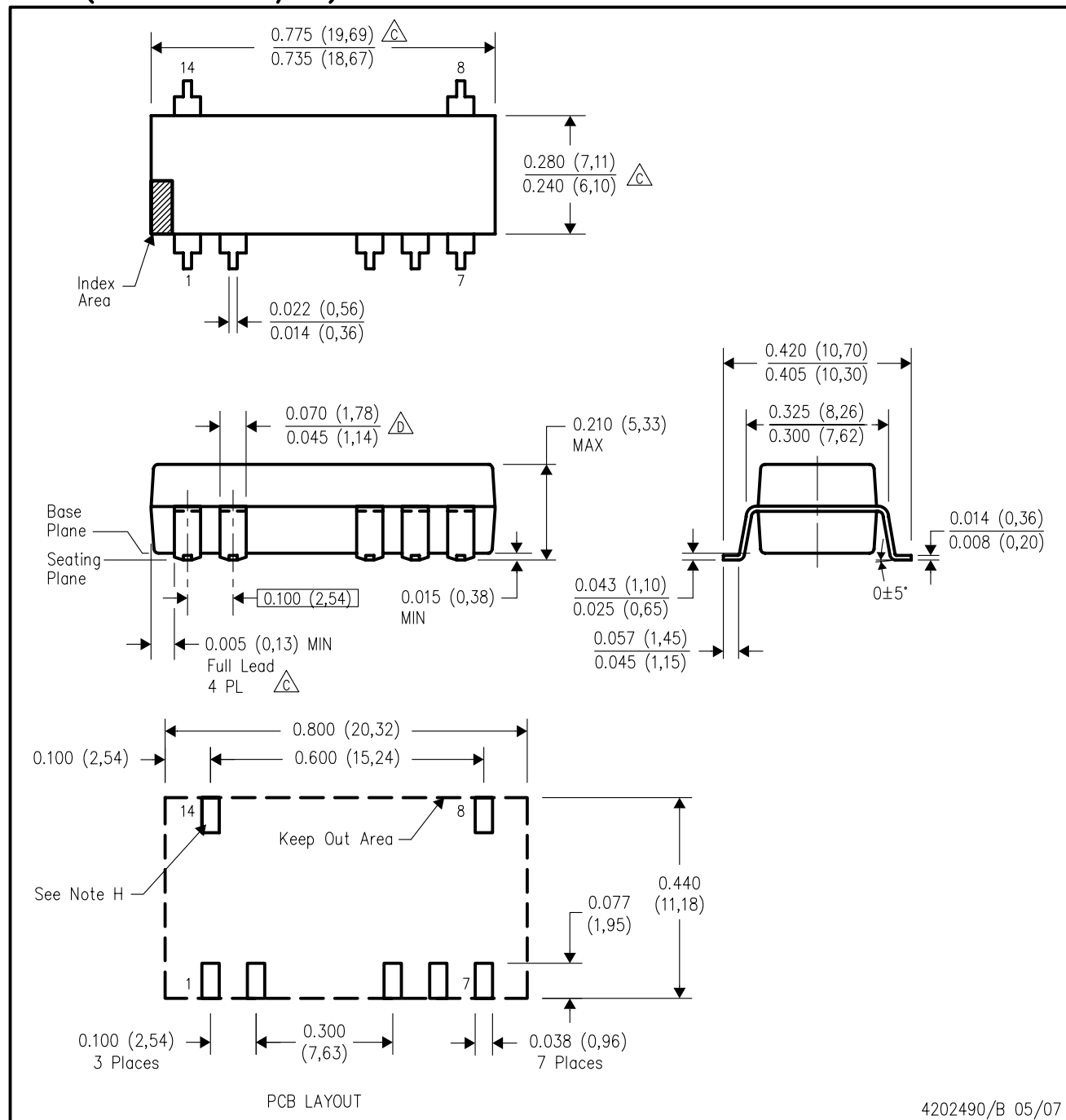
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Dimensions are measured with the package seated in JEDEC seating plane gauge GS-3.
  - Dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 (0,25).
  - Dimensions measured with the leads constrained to be perpendicular to Datum C.
  - Dimensions are measured at the lead tips with the leads unconstrained.
  - G. Pointed or rounded lead tips are preferred to ease insertion.

- Lead shoulder maximum dimension does not include dambar protrusions. Dambar protrusions shall not exceed 0.010 (0,25).
- I. Distance between leads including dambar protrusions to be 0.005 (0,13) minimum.
- J. A visual index feature must be located within the cross-hatched area.
- K. For automatic insertion, any raised irregularity on the top surface (step, mesa, etc.) shall be symmetrical about the lateral and longitudinal package centerlines.
- L. Falls within JEDEC MS-001-AA.



## DUA (R-PDSO-G7/14)

## PLASTIC SMALL-OUTLINE



4202490/B 05/07

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 (0,25).
  - D. Lead shoulder maximum dimension does not include dambar protrusions. Dambar protrusions shall not exceed 0.010 (0,25).
  - E. Distance between leads including dambar protrusions to be 0.005 (0,13) minimum.
  - F. A visual index feature must be located within the cross-hatched area.
  - G. For automatic insertion, any raised irregularity on the top surface (step, mesa, etc.) shall be symmetrical about the lateral and longitudinal package centerlines.
  - H. Power pin connections should be two or more vias per input, ground and output pin.

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